

Product Change Notification

CN-202406002F

Issue date: 31 Oct 2024

Effective date: 01 Feb 2025

Here's your personalized quality information concerning products our customers and partners purchased from Nexperia.

For more details please contact your respective Nexperia CSR/AM.



Phase 2 of introduction of Wingskysemi (WSS) Shanghai Dingtai Jiangxin Technology Co., Ltd. China (C125 process)

Change Category

[]Wafer	[]			
Fab	Assembly		[]Toot	
Process	Process	[X] Product Marking	[] Test Location	[] Design
[] Wafer Fab	[] Assembly	[] Mechanical Specification	[] Test	[] Errata
	•	Specification	Process	[] Electrical
Materials	Materials	[]	[] Test	spec./Test
[X] Wafer	[]	Packing/Shipping/Labeling	Equipment	coverage
Fab	Assembly		Equipment	
Location	Location			

Details of this change

Expansion of wafer fab capacity by introduction 12" Wingskysemi (WSS) Shanghai Dingtai Jiangxin Technology Co., Ltd. China to support customer demand.

- Additional wafer fab capacity source for C125 process at 12" Wingskysemi (Shanghai, China).
- Qualification in accordance JEDEC and Automotive Electronics Council Q100.
- Phase 1 (PCN CN-202402004F) was issued on 28 June 2024 and is successfully implemented.

Qualification_Report_PCN_CN-202406002F_WSS_C125_phase_2.pdf: https://qcm.nexperia.com/Document/DOC-583631/Qualification_Report_PCN_CN-202406002F_WSS_C125_phase_2.pdf

Why do we implement this change?

- To support increased customer demand.
- Front End capacity expansion.
- Supply flexibility.
- Order Lead-Time Improvement.

Identification of affected products

- The traceability is given by the diffusion location identifier which is indicated on product marking (if space permits) and in Product Manufacturing Code (PMC) on reel and box labels.
- Diffusion location identifier on product marking and PMC on reel and box labels code 1st character represent the diffusion location, "w" for Wingskysemi (WSS).

Management summary

Phase 2 of introduction of Wingskysemi (WSS) Shanghai Dingtai Jiangxin Technology Co., Ltd. China (C125 process).

Product availability

Production

Planned first shipment: 31 Jan 2025

Sample information

Samples are available upon request

Impact

No impact to the product's functionality anticipated

- Matching wafer PCM (Process Control Modules) and product parameters by 1.5 delta/sigma.
- No change in form, fit, function, quality, workability and reliability anticipated.
- No change in data sheet and test limits.
- No change in ordering code 12NC (sales part number).

Data sheet revision

No impact to existing datasheet

Disposition of old products

Not applicable, additional wafer fab location.

Feedback

Your acknowledgement of this change, conform JEDEC J-STD-046, is expected till 30 Nov 2024. Lack of acknowledgement of the PCN constitutes acceptance of the change.

Additional information

View Change Notification Online

Remarks

Wafer fab diffusion location identifier on product (topside) marking (if space permits) and on reel and box labels: "w"= Wingskysemi (WSS) Shanghai Dingtai Jiangxin Technology Co., Ltd. China. PCN samples are available upon request via Helpdesk+ from BG IC Solutions sample store in Nijmegen, The Netherlands. Maximum sample order 300 pieces per type.

Contact and support

For all Quality Notification content inquiries, please contact your local Nexperia Sales Support Team.

For specific questions on this notice or the products affected please contact our specialist directly: pcn@nexperia.com

In case of distribution, please contact you distribution partner.

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